Effective June 2017 Supersedes December 2008

FP1006 High frequency, high current power inductors



Product features

- 10.2 x 8.0 x 6.0mm surface mount package
- Ferrite core material
- High current carrying capacity, Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 85nH to 220nH
- Current range from 38 to 100 amps
- Frequency range up to 2MHz

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Point-of-load modules
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- Graphics cards and battery power systems
- DCR sensing

Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





			Produc	t Specifications			
Part Number	OCL ¹ ± 10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps	I _{sat} 1⁴ @ 25°C (Amps)	I _{sat} 2⁵ @ 125°C (Amps)	DCR (mΩ) @ 20°C	K-factor
R1 Version							
FP1006R1-R08-R	85	61		100	70		454
FP1006R1-R10-R	100	72		85	64		454
FP1006R1-R12-R	120	86	53	71	53	0.27 ± 12%	454
FP1006R1-R16-R	160	115		55	40		454
FP1006R1-R22-R	220	158		38	28		454
R2 Version						-	
FP1006R2-R08-R	85	61		100	70		454
FP1006R2-R10-R	100	72		85	64		454
FP1006R2-R12-R	120	86	45	71	53	0.36 ± 8.6%	454
FP1006R2-R16-R	160	115		55	40		454
FP1006R2-R22-R	220	158		38	28		454

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10Vrms, 0.0Adc

2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, Isat1

3~ I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.

4 I_{sat} 1: Peak current for approximately 20% rolloff at +25°C.

5 Isat2: Peak current for approximately 20% rolloff at +125°C.

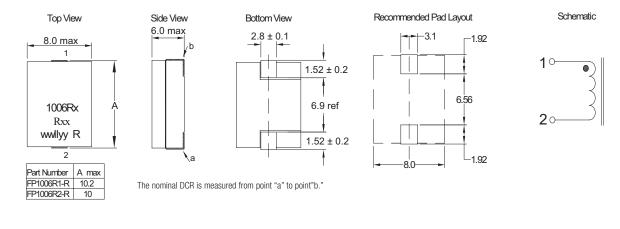
6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I * 10^{-3}$, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ∆I (peak-to-peak ripple current in amps).

7 Part Number Definition: FP1006Rx-Rxx-R

• Rx is the DCR indicator

• FP1006 = Product code and size • Rxx= Inductance value in μ H, R = decimal point • "-R" suffix = RoHS compliant

Dimensions- mm



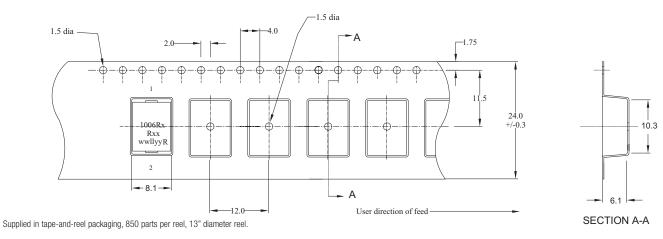
Part Marking:

1006Rx (Rx = DCR Indicator) Rxx = Inductance value in μH . (R = Decimal point)

wwllyy = Date code

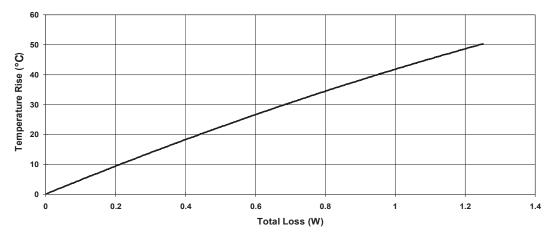
R = Revision level

Packaging information - mm

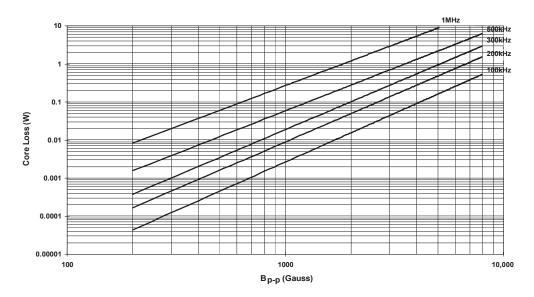


FP1006 High frequency, high current power inductor

Temperature rise vs total loss

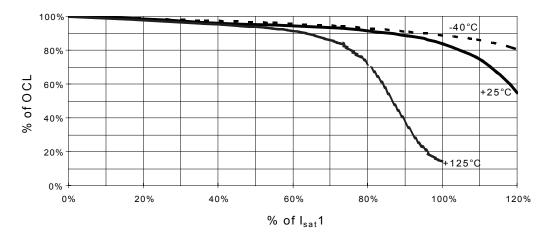


Core loss vs Bp-p



Inductance characteristics

% of OCL vs. % of $I_{sat}\,1$



Solder Reflow Profile

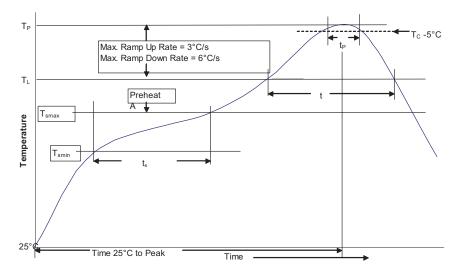


Table 1 - Star	ndard SnF	Pb Solder (T _C)	
	Volume	Volume	
Package	mm ³	mm ³	
Thickness	<350	≥350	
<2.5mm	235°C	220°C	
≥2.5mm	220°C	220°C	
Table 2 - Lea	d (Pb) Fre	e Solder (T _C)	
Table 2 - Lea	d (Pb) Fre Volume	e Solder (T _C) Volume	Volume
Table 2 - Lea Package		•••	Volume mm ³
	Volume	Volume	
Package	Volume mm ³	Volume mm ³	mm ³
Package Thickness	Volume mm ³ <350 260°C	Volume mm ³ 350 - 2000	mm ³ >2000

Reference JDEC J-STD-020

Powerina Business Worldwide

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder 150°C	
Preheat and Soak	 Temperature min. (T_{smin}) 	100°C		
	 Temperature max. (T_{smax}) 	150°C	200°C	
	 Time (T_{smin} to T_{smax}) (t_s) 	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (T _P)*		Table 1	Table 2	
Time $(t_p)^{\star\star}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (Tp to Tsmax)		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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Eaton Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States www.eaton.com/electronics

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